

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	636611	(strain stress pressure force load) near3 (sens\$5 detect\$5 transducer measur\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:50
L2	8955	1 and (semicond\$6) near3 (sheet film layer pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:47
L3	1903	2 and (metal\$5) near3 (conduct\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:49
L4	1702	3 and (contacts)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:34
L5	905	4 and (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:58
L6	644	5 and (voltage)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:58
L7	536	6 and (plat\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:38
L8	25	7 and (mesa)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:38
L9	1	8 and (inhomogeneous)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:39
L10	32	4 and (inhomogeneous)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:47
L11	26	10 and (indium antimonide)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:42
L12	10	11 and (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:41

L13	12019	(inhomogeneous)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:47
L14	660	13 and (semicond\$6) near3 (sheet film layer pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:01
L15	141	14 and (metal\$5) near3 (conduct\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:01
L16	85	15 and (interface Schottky)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:50
L17	73	16 and (strain stress pressure force load)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:50
L18	8	17 and (voltage near3 chang\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:50
L19	3	14 and (metal\$5) near3 (shunt\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:01
L20	38	14 and (shunt\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:58
L21	35	20 and (metal\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:58
L22	29	21 and (voltage)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:58
L23	21	22 and (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:59
L24	3	23 and (Schottky)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:59

L25	11	23 and (hybrid)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:59
L26	313376	(semicond\$6) near3 (sheet film layer pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:01
L27	30918	26 and (metal\$5) near3 (conduct\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:01
L28	161	26 and (metal\$5) near3 (shunt\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:03
L29	5	28 and (strain stress force load pressure) near3 (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:02
L30	101	28 and (strain stress force load pressure)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:02
L31	36	30 and (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:02
L32	36	31 and (shunt\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 12:07

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	278372	semicond\$5 near3 (film layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:09
L2	150	1 and (metal\$5) near3 (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:14
L3	94	2 and (strain force load stress pressure)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:10
L4	33	3 and (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:06
L5	8	4 and (indium)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:05
L6	0	4 and (Antimomide)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:05
L7	3	3 and (Schottky)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:09
L8	754	(Schottky) near3 (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:09
L9	501	8 and (semicond\$5) near3 (pad sheet film layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:13
L10	2	9 and (metal\$5) near3 (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:13
L11	1	10 and (strain force load stress pressure)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:11
L12	17	"6034404" "6338275" "5663507"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:13

L13	4	12 and (semicond\$5) near3 (pad sheet film layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:14
L14	0	13 and (metal\$5) near3 (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:16
L15	0	13 and (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:16

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L1	278372	semicond\$5 near3 (film layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:09
L2	150	1 and (metal\$5) near3 (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:14
L3	94	2 and (strain force load stress pressure)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:10
L4	33	3 and (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:06
L5	8	4 and (indium)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:05
L6	0	4 and (Antimomide)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:05
L7	3	3 and (Schottky)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:09
L8	754	(Schottky) near3 (interface)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:09
L9	501	8 and (semicond\$5) near3 (pad sheet film layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:13
L10	2	9 and (metal\$5) near3 (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:13
L11	1	10 and (strain force load stress pressure)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:11
L12	17	"6034404" "6338275" "5663507"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:13

L13	4	12 and (semicond\$5) near3 (pad sheet film layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:14
L14	0	13 and (metal\$5) near3 (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:20
L15	0	13 and (shunt\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:16
L16	3	13 and (metal\$5) near3 (conduct\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:20
L17	3	16 and (contact)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:20
L18	3	16 and (contacts)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:22
L19	0	18 and (mesa)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:24
L20	0	18 and (inhomogeneous)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/03/21 11:24